

# **ATROX® 590-4HT25**

**Electrically and Thermally Conductive Die Attach Adhesive** 

#### **DESCRIPTION**

ATROX 590-4HT25 is a thermosetting conductive die attach adhesive with 25µm spacers with very high thermal conductivity designed for high-power semiconductors and exposed pad semiconductor packages. ATROX 590-4HT25 die attach adhesive has excellent adhesive strength to Cu, NiPdAu leadframes, and solder-mask surfaces. ATROX 590-4HT25 has low outgassing which minimizes oven contamination and is ideal for excellent MSL performance.

READ ENTIRE TECHNICAL DATA SHEET BEFORE USING THIS PRODUCT

# **TYPICAL PROPERTIES**

Material Properties	Method	Value	Remarks		
A. Uncured					
Chemical type		Thermosetting			
Color	Visual	Grey	_		
Viscosity at 25 °C at 5.0 RPM	ASTM D2196-99	17,100 cps	Brookfield Spindle 51		
Thixotropic index (0.5 RPM/5.0 RPM)	ASTM D2196-99	5.60	Brookfield Spindle 51		
Spacer size		25 microns			
Pot Life @ 23 °C (elapsed time for 25% increase in viscosity)	ISO 10364:1993	24 hours	Brookfield Spindle 51		
Storage Temperature		-40 °C			
Shelf Life @ -40 (°C/°F)		6 months			
B. Cured					







Material Properties	Method	Value	Remarks
Glass Transition (Tan δ Max)	DMA	70 °C	
Modulus at 25 °C	DMA	6.0 GPa	
Modulus at 260 °C	DMA	0.50 GPa	
CTE 1 (below Tg)	TMA	50 ppm	
CTE 2 (below Tg)	TMA	175 ppm	
Thermal Conductivity:	Laser Flash	8 W/mK	
Volume Resistivity	4-Point Probe	0.000035 Ohm-cm	

## DIE SHEAR STRENGTH (3 mm x 3 mm)

# A. Metallized Die (3mm x 3mm)

Lead Frame	Cure Condition	Measuring Temperature	Value
Ag	30min + 175 °C/120min	260 °C	5.6 Kg-F
NiPdAu (PPF)	30min + 175 °C/120min	260 °C	6.0 Kg-F
Cu	30min + 175 °C/120min	260 °C	6.5 Kg-F

### **MATERIAL APPLICATION**

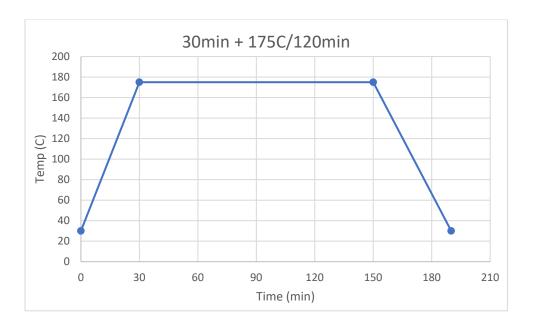
ATROX 590-4HT25 is formulated to be applied using a time pressure pump equipped on most die bonders. The material should be consistently dispensed over time. Equipment settings need to be optimized for desired material deposition response based on model and configuration.





#### **CURE**

ATROX 590-4HT25 cures using a ramp profile with 30-minute ramp to 175 °C and soak for 120 minutes. It is recommended that the cure schedule includes at ramp at 5 to 10 °C and a controlled cooling cycle to minimize thermal stresses. Depending on the thermal mass of the application cure times may vary and should be optimized by the end user.



#### **RELIABILITY PERFORMANCE**

ATROX 590-4HT25 is recommended for excellent reliability with stable Electrical and Thermal performance during MSL and Thermal Cycling. There is no limitation on die size for metalized die packages. However, it is recommended to consult with your local technical service for optimizing critical parameters for specific packages.

It is also possible to assemble Bare Silicon dies up to 10 mm2 with excellent electrical and thermal performance. For die sizes larger than 10 mm2, kindly contact MacDermid Alpha for assistance.

#### **CLEAN-UP**

Uncured material may be cleaned from dispenser components and surfaces with a variety of solvents, including IPA, acetone, MEK, methylene chloride, etc. Always wash and dry thoroughly prior to re-use of the dispenser components. The cleaning technique should be active cleaning of the components – flush, wash, or wipe, followed by a drying step to ensure a clean, dry surface. Do not soak since this can solubilize the hardener within the uncured resin and curing (very difficult to remove). Contact your equipment supplier to ensure the solvent is







compatible with their components. Clean and maintain dispense valves as recommended by the equipment manufacturer.

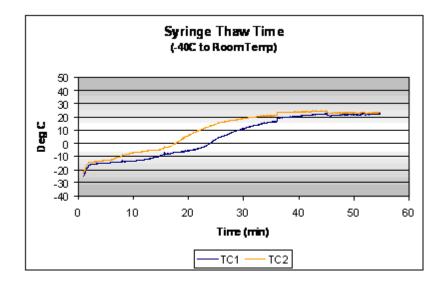
#### **PACKAGING SIZES**

ATROX® 590-4HT25 is available in 5 or 10 cc EFD or Musashi syringes.

#### **SHIPPING & HANDLING**

Material is normally shipped in insulated boxes using dry ice to ensure that the ATROX® 590-4HT25 maintains all its properties. On receipt, it must be ensured that dry-ice remnants are present in the insulated shipping box. If there is no dry ice, or if the material is not cold, then please contact MacDermid Alpha Electronics Solutions immediately. Exposure to elevated temperatures during shipment and storage will compromise the performance aspect of the material adversely.

It is recommended to store the syringes of material at -40 °C for a maximum shelf life of 6 months. The material must be allowed to thaw before usage. Typical thawing times for 5cc and 10cc syringes are presented in the chart below. Remove the syringe from the freezer and set it aside for one hour, allowing it to thaw at room temperature until it reaches room temperature. To prevent contamination of unused products, do not return any material to its original container.







#### **SAFETY & WARNING**

It is recommended that the company/operator read and review the Safety Data Sheets for the appropriate health and safety warnings before use. **Safety Data Sheets are available.** 

#### **CONTACT INFORMATION**

# To confirm this document is the most recent version, please contact techinfo@MacDermidAlpha.com

www.macdermidalpha.com

North America 3950 Johns Creek Ct, Suite 300 Suwanee, GA 30024 USA 908.791.2300	Europe Unit 2, Genesis Business Park Albert Drive Woking, Surrey, GU21 5RW, UK 44.01483.758400	<b>Asia</b> 14 Joo Koon Crescent, Singapore 629014 65.6430.0700
--	--	---

Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

DISCLAIMER: All statements, technical information and recommendations contained herein are based on tests we believe to be reliable, but the accuracy or completeness thereof is not guaranteed. No statement or recommendation shall constitute a representation unless set forth in an agreement signed by officers of seller and manufacturer. NO WARRANTY OF MERCHANTABILITY, WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE OR ANY IMPLIED WARRANTY IS MADE. The following warranty is made in lieu of such warranties and all other warranties, express, implied, or statutory. Products are warranted to be free from defects in material and workmanship at the time sold. The sole obligation of seller and manufacturer under this warranty shall be to replace any noncompliant product at the time sold. Under no circumstances shall manufacturer or seller be liable for any loss, damage or expense, direct, incidental or consequential, arising out of the inability to use the product. Notwithstancing the foregoing, if products are supplied in response to a customer request that specifies operating parameters beyond those stated above, or if products are used under conditions exceeding said parameters, the customer by acceptance or use thereof assumes all risk of product failure and of all direct, indirect, incidental and consequential damages that may result from use of the products under such conditions, and agrees to exonerate, indemnify, defend and hold harmless MacDermid, Incorporated and its affiliates therefrom. No suggestion for product use nor anything contained herein shall be construed as a recommendation to use any product in a manner that infringes any patent or other intellectual property rights, and seller and manufacturer assume no responsibility or liability for any such infringement.

© 2019 MacDermid, Inc. and its group of companies. All rights reserved. "(R)" and "TM" are registered trademarks or trademarks of MacDermid, Inc. and its group of companies in the United States and/or other countries.

